IPC ASSOCIATION CO	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under bointernational and Pan-American copyright conventions.		der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typhttp://www.ipc.org/IPC-175x Distribute				e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				ials and Mfg Information				
upplier Ir	nformation													
Company name*			Company unique ID			J	Unique ID Authority				Response Date*			
nsemi										2025-06-07				
Contact Name	e	Title - Contact			I	Phone - Contact*				Email - Contact*				
Product-Env	y-Stewards	Product Enviro Compliance			]	NA				Product-Env-Stewards@onsemi.com				
uthorized R	Representative*	Title - Representative			I	Phone - Representative*				Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com			
Re	Requester Item Number		Mfr Item Number Mfr Item		Ifr Item Name		Effective Date	Version	n Manufacturing Site		W	eight*	UOM	Unit Type
		NSVS1002CLTWG 100V 2.5A		100V 2.5A NPN Lo	V 2.5A NPN Low saturation BJT		2025-06-07 PBB		BB	25.42909		mg	Each	
Ianufactu	uring Proccess Informa	ation											·	
Terminal Plating / Grid Array Material Termi			erminal Base	rminal Base Alloy J-STD-020 MSL Rating			Peak Process Body Temperature Max Time at Peak				Temperatu	re Numb	er of Reflow Cyc	eles
Ma	atte Tin (Sn) - annealed		CU Alloy	1			260		C	30	second	s <b>3</b>		
omments														
vel 1 - maxii	mum time at peak tempera	ture during sol	dering is 10-3	30 seconds										
or more info	ormation regarding materia	l composition	please refer to	page 3										

RoHS Material Composition Declaration			Declaration Type *	Detailed						
Priective 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Isability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale appli										
RoHS Declaration * 4 - Item(s	) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature Ra	astislav Drska	-En								

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.022383	mg	Supplier	Silicon (Si)	7440-21-3		0.0224	mg
Die Attach Solder	0.967556	mg	Supplier	Silver (Ag)	7440-22-4		0.0242	mg
			A	Lead (Pb)	7439-92-1	7a	0.895	mg
			Supplier	Tin (Sn)	7440-31-5		0.0484	mg
Lead Frame	9.8712	mg	Supplier	Silver (Ag)	7440-22-4		0.4936	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0118	mg
			Supplier	Iron (Fe)	7439-89-6		0.2369	mg
			Supplier	Copper (Cu)	7440-50-8		9.121	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0079	mg
Mold Compound-Black	14.238721	mg	Supplier	Polymer 1,1'-biphenyl with formaldehyde and Phenol, glycidyl ether	1201169-35-8		0.7119	mg
			Supplier	Polycondensate of 4,4'-bis(methoxymethyl)biphenyl and phenol	205830-20-2		0.356	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0712	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		13.0996	mg
Plating	0.298767	mg	Supplier	Tin (Sn)	7440-31-5		0.2988	mg
Wire Bond	0.030464	mg	Supplier	Palladium (Pd)	7440-05-3		0.0003	mg
			Supplier	Copper (Cu)	7440-50-8		0.0302	mg